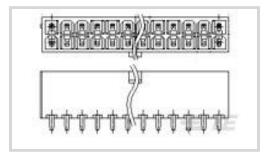


ATX Power

TE Internal #: 4-1775099-6 PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 1.4 mm [. 055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray, ATX Power

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



EU RoHS Compliance: Compliant

EU ELV Compliance: Compliant

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Wire-to-Board

Features

Other

EU RoHS Compliance

EU ELV Compliance

connectivity

Compliant

Compliant

Product Type Features

PCB Connector Assembly Type	PCB Mount Header							
Connector System	Wire-to-Board							
Sealable	No							
Connector & Contact Terminates To	Printed Circuit Board							
Configuration Features								
PCB Mount Orientation	Vertical							
Number of Positions	18							
Number of Rows	2							
Electrical Characteristics								
Operating Voltage	250 VAC							
Body Features								
Primary Product Color	lvory							
Contact Features								
Contact Underplating Material	Nickel							
Contact Underplating Material Thickness	1.27 μm[50 μin]							

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray, ATX Power



PCB Contact Termination Area Plating Material Finish	Matte					
Contact Mating Area Plating Material Thickness	3.05 μm[120.07 μin]					
Mating Tab Width	1.14 mm[.044 in]					
PCB Contact Termination Area Plating Material Thickness	3.05 μm[120.07 μin]					
Contact Layout	Matrix					
Mating Tab Thickness	1.1 mm[.043 in]					
PCB Contact Termination Area Plating Material	Tin					
Contact Mating Area Plating Material Finish	Matte					
Contact Mating Area Plating Material	Tin					
Contact Type	Pin					
Contact Current Rating (Max)	9 A					
Termination Features						
Rectangular Termination Post & Tail Width	1.14 mm[.044 in]					
Rectangular Termination Post & Tail Thickness	.55 mm[.021 in]					
Termination Method to PCB	Through Hole - Solder					
Mechanical Attachment						
Mating Retention	Without					

Mating Alignment Type	Polarization						
PCB Mount Retention	With						
PCB Mount Alignment	Without						
Connector Mounting Type	Board Mount						
Mating Alignment	With						
Housing Features							
Housing Material	PA 9T						
Centerline (Pitch)	1.4 mm[.055 in]						
Dimensions							
Row-to-Row Spacing	4.2 mm[.165 in]						
Usage Conditions							
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]						
Operation/Application							
Circuit Application	Power						
Industry Standards							

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray, ATX Power



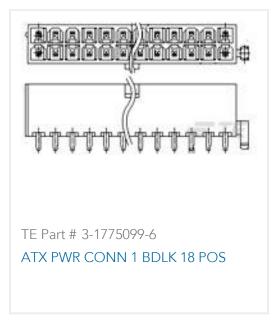
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Method	Tray			
Product Compliance For compliance documentation, visit the product page on TE.com>				
EU RoHS Directive 2011/65/EU	Compliant			
EU ELV Directive 2000/53/EC	Compliant			
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC			
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.			
Solder Process Capability	Wave solder capable to 265°C			

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge

based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

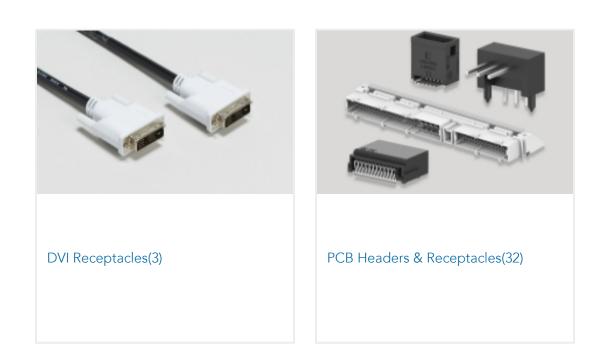


Also in the Series | ATX Power

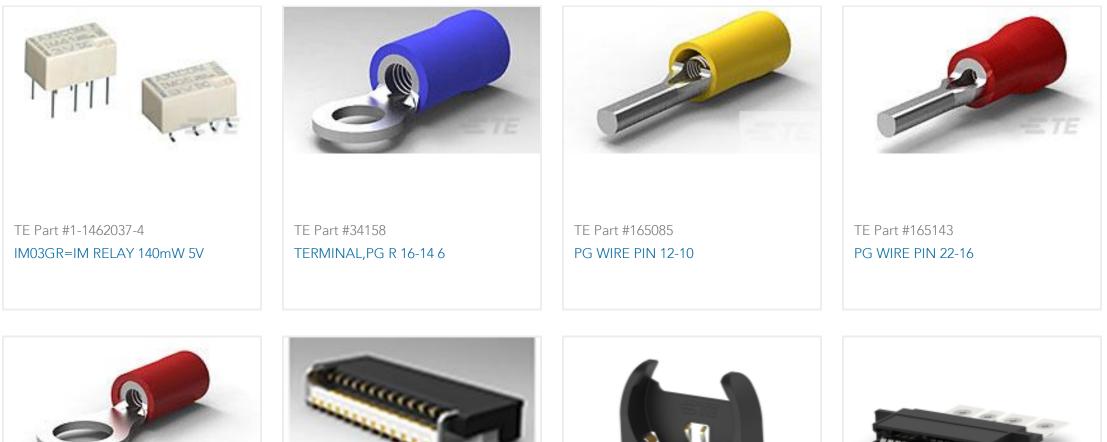
C For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray, ATX Power





Customers Also Bought



TE Part #130014

TE Part #1-2040832-8

TE Part #2-1775485-4



TE Part #2204600-1

TERM, R, PG, 22-16, M5	EMBOSS TAPING 0.25FPC BF-L-1.3	BATTERY HOLDER, 3.2MM, BLK, low	PDBB 125A POWER CONNECTOR,
		profile	BOARD VERSION

TE Part #6-1734598-2 1.25 WTB HDR DIP, L=2.3, 8 POS

Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-1775099-6_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_4-1775099-6_E.3d_igs.zip

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray, ATX Power



English

Customer View Model ENG_CVM_CVM_4-1775099-6_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English